

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Innovative **Technology** for a **Connected** World

EMI Absorber Q-ZORB

Q-ZORB RFSW-20-PSA PN 2388



Q-ZORB RFSW-S-020-PSA, PN 2388, is a flexible elastomeric magnetic absorbing material. The material is designed to perform well for surface current attenuation. It can be used to lower the Q of cavities and reduce EMI. It is easily bonded using contact adhesives or it can be supplied with a pressure sensitive acrylic adhesive (PSA).

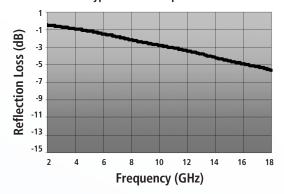
FEATURES AND BENEFITS

- Extremely tough and flexible
- Can be die-cut to a variety of shapes and components
- Supplied with pressure sensitive adhesive for ease of installation
- Designed for good surface current attenuation from 10 GHz and beyond
- Useful in cavities to lower the Q and reduce suppress electromagnetic interference
- Performs well in millimeter wave applications
- Well suited to outdoor applications
- Useful for antenna interference reduction
- Withstands direct exposure to environment

SPECIFICATIONS

TYPICAL PHYSICAL PROPERTIES		
Size	2388	24" x 24" (Standard)
	238825	12" x 12"
	2388 - S	4" x 6"
Thickness		0.20" nominal
Weight		.50 lb/sq ft
Temperature Maximum		325 °F
Color		Gray
Environmental		Good general weather and chemical resistance
Bonding		Supplied with 3M 9485 PSA
Fire Retardant Rating		UL-V0

Typical electrical performance



NOTES

The physical properties and electrical performance property above are typical for the material, but not intended for use in specifications or for the acceptance inspection criteria because of variations in testing methods, conditions and configurations

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EMI-Q-ZORB RFSW-20-PSA PN 2388 1110

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